

2020 05 26

40.6
493.67
96.28
121,593
23,714
12 / 55.00/31.77

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IDM

688396

	2018A	2019A	2020E	2021E	2022E
	6271	5743	6543	7515	8667
(+/-%)	6.7%	-8.4%	13.9%	14.8%	15.3%
	429	401	472	601	702
(+/-%)	511.0%	-6.7%	17.8%	27.3%	16.8%
EPS	0.35	0.33	0.39	0.49	0.58
PE	115	123	105	82	70

■ IDM IDM

MOSFET

2019
2019

2020 Q1

■ BCD MOSFET MOSFET

-100V 1500V
2018 MOSFET
IGBT Trench-FS
600V-6500V IGBT
6 247 8 133
BCD 5-700V
BCD BCD SOI BCD BCD
GaN SiC

400
36%

	SiC Si		GaN	SiC Si		
	2018		5	2024	20	
	"	"				
				IDM		
	2020-2022			4.73	6.01	7.02
EPS	0.39	0.49	0.58	PE	104.60X	82.16X 70.34X
	"	"				



[Redacted]

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- 32

PC

ROE

2020 1 31

2017

2017

MOSFET

IGBT

2017

Si SiC GaN

SiC

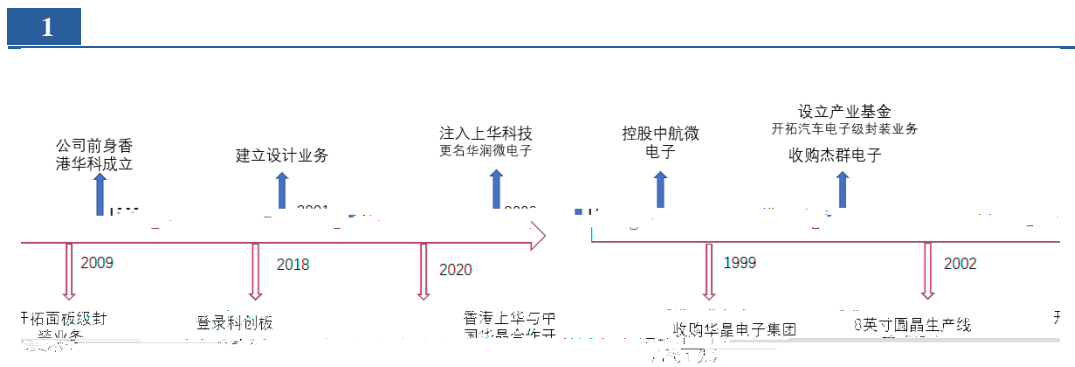
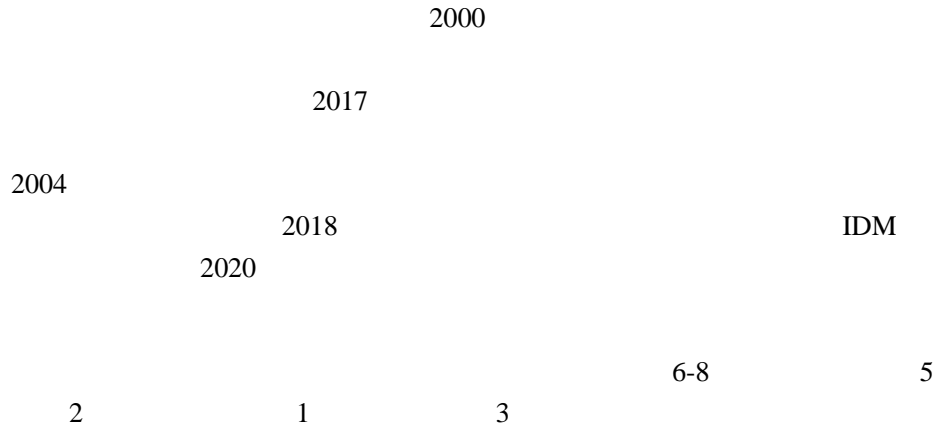
MOSFET

~



1. IDM

1.1 IDM



2017-2019 2020 Q1 17.62% 25.20% 22.84%

24.92% 2018

20.68% 2019

24.67% 2020 Q1 24.92%

2017-2019 2020 Q1 0.70 4.29

4.01 1.14 2017 2018 2019 2020Q1

512.9% -6.5% 450.4% 2018

2019 43.97%

2019 Q3 Q4 -33.28% 701.13% 2020 Q1

450.35% 2019

2017- 2019 2020 Q1 16.67

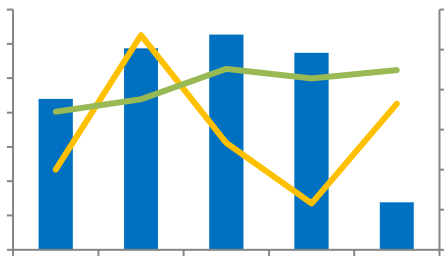
14.82 5.76 2.71 28.38% 23.64% 10.04%

19.62%

2017- 2019 2020 Q1 97.47 99.92

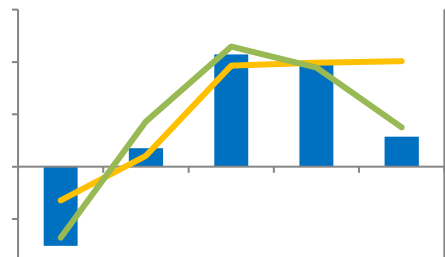
100.95 145.57 54.13% 49.76% 36.70% 26.03%

5



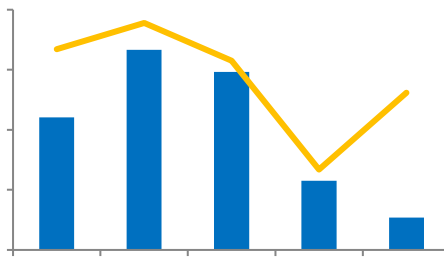
Wind

6 ROE



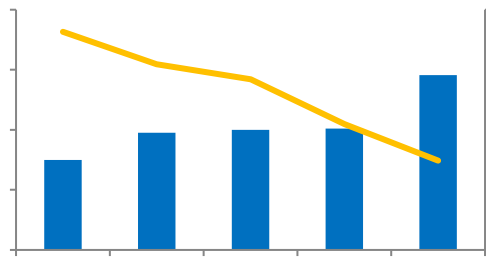
Wind

7

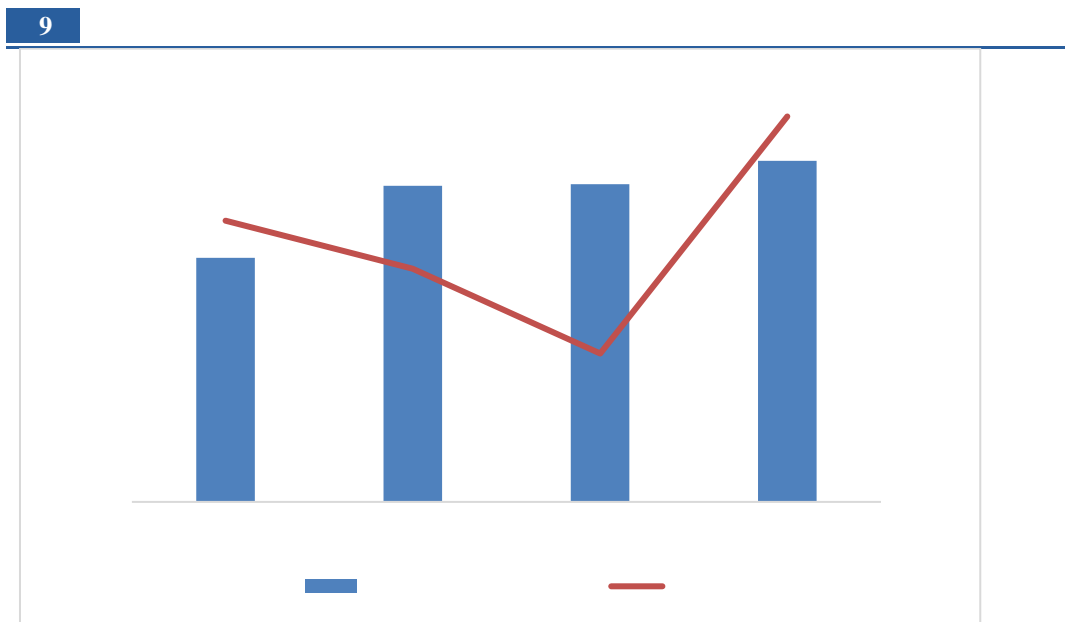


Wind

8

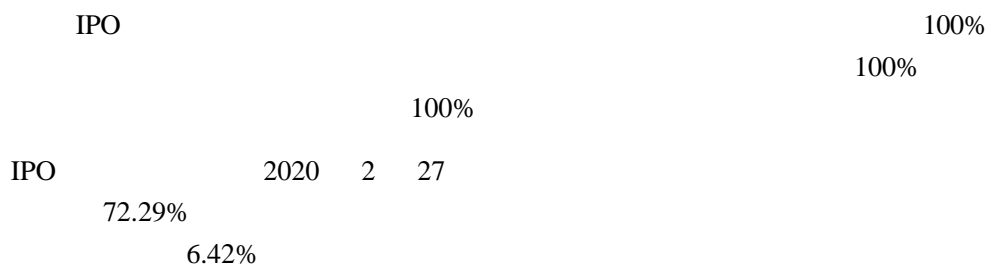


Wind



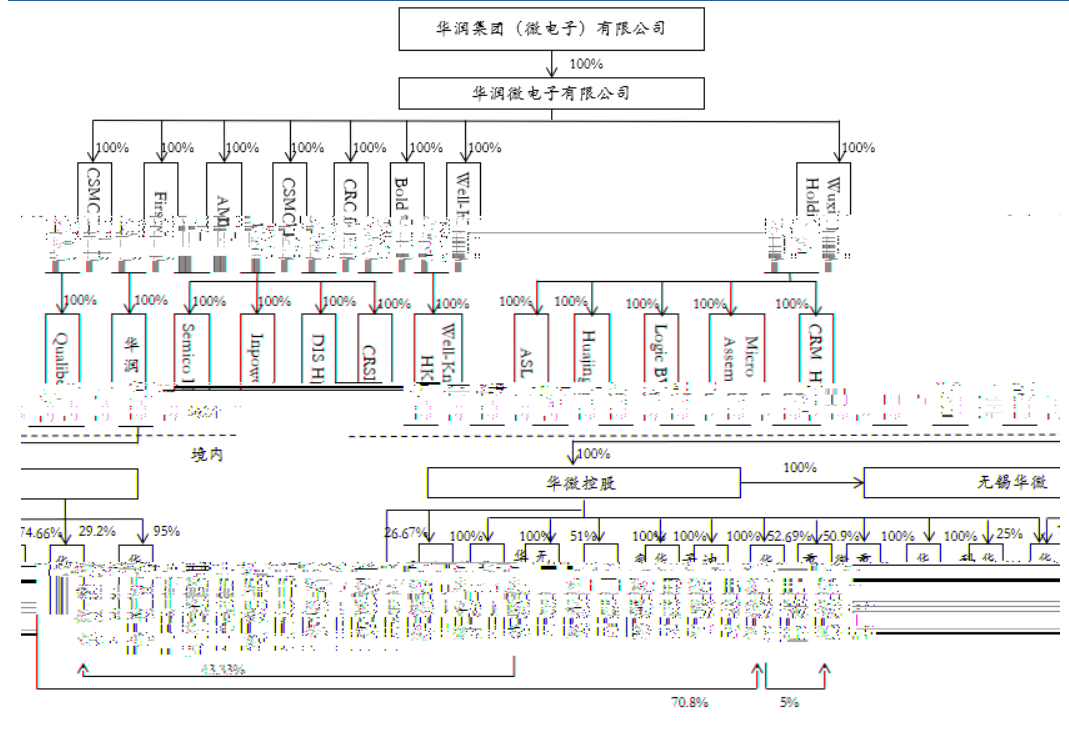
1.3

8



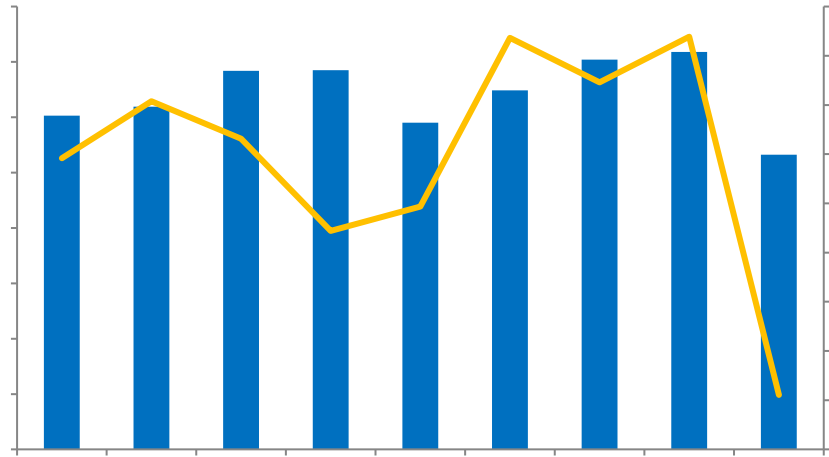
10

2020 1 31



IPO	30	"	8		
" "		" "		"	
1	8	BCD	0.13um/0.11um	8	MEMS
			2018	9	2021
			16,000	8	11
8		14.5%			
2		" "		"	" "
		" "		" "	
		MEMS			
3				50%	20%
					30%

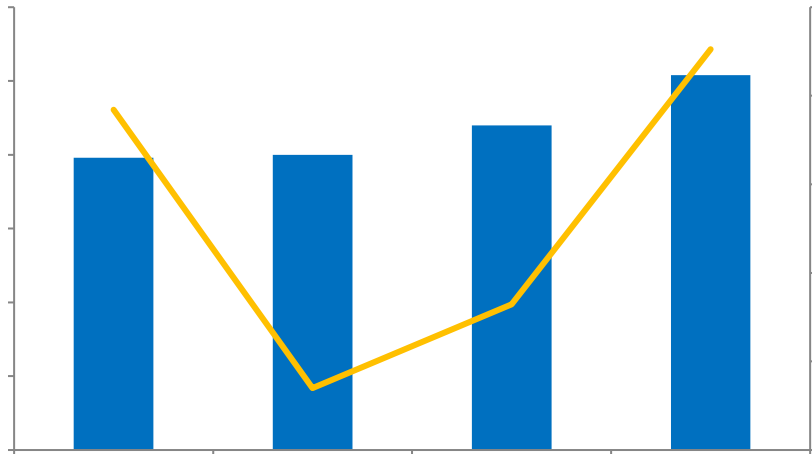
5G							
	5G		2019	8	5G		
		8	21.9		12	541.4	0.7%
	18.7%	2019	5G		1376.9		
	3.7%						
2020							5G
	5G		1	546.5	4	1638.2	
26.9%	40.2%	5G					
	2020	5G				2020	5G
		1500					2020
5G		1.75	2.25	5G			



IDC

2019	Q4	7.5%	253.5	2019	Q2	Q3
				IDC		
				8.9%	2020	
				3.4%	2024	
2019-2024	CAGR	5.6%				
					2020Q1	2020
					1166	

14

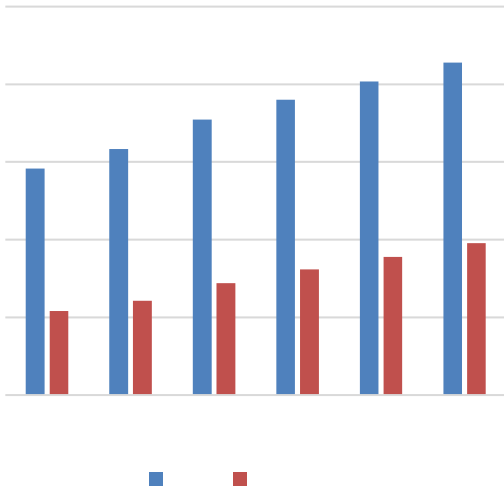


IDC

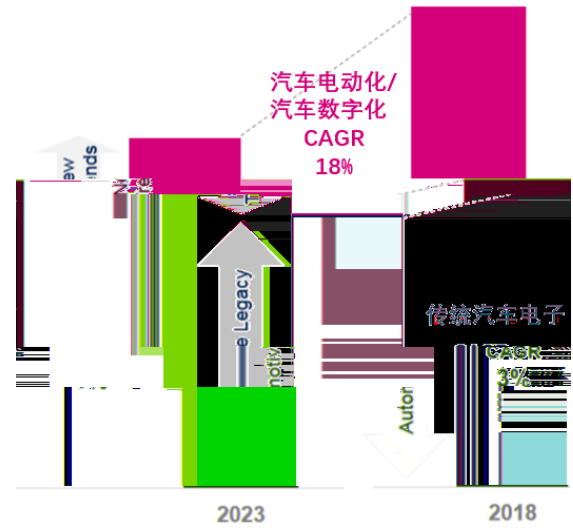
2018	9783	15833	6073
2022	21399	7.82%	12.66%
			10%

35% 10%~25% / 18% 3%

15



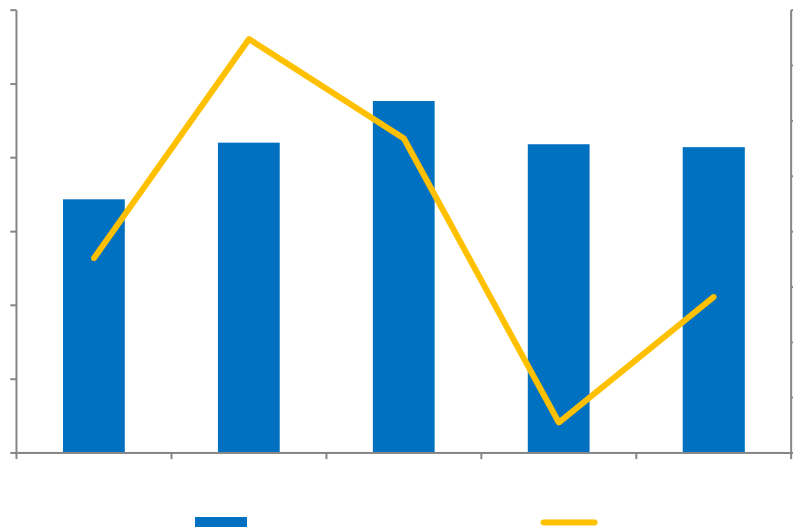
16



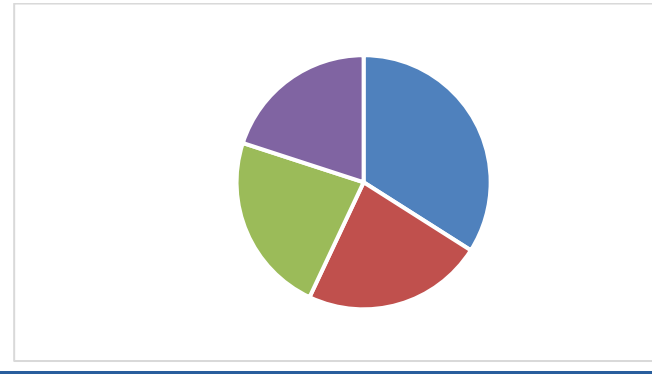
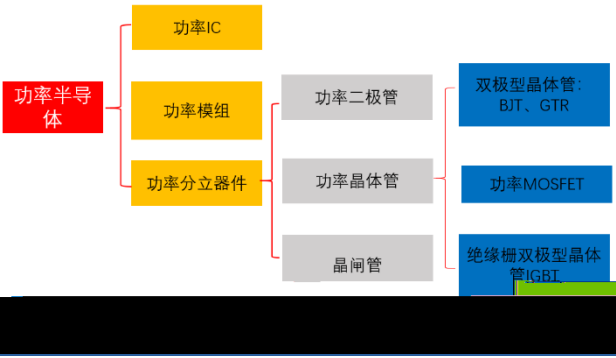
strategy analytics ST

2018 4,767 2017 13.7% 2019 2020 0.9%

17



Gartner



5G

1

2

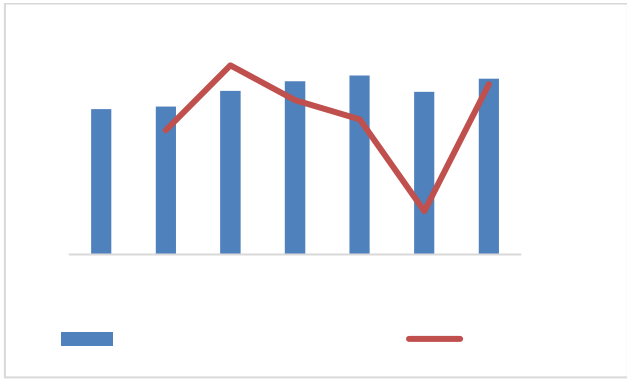
	71	MHEV	/	HEV/PHEV
	BEV	27%	90	305
		330%		350
	2018		200	
			2025	1000
2030	2800		2018	
	60	2020	70	2022
80				

3

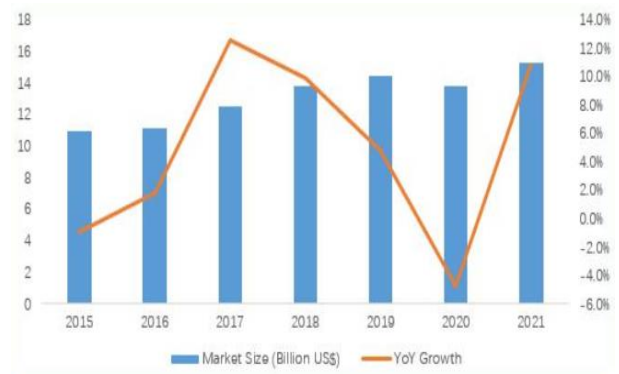
	0.79	10.67
	5G	
PA		Massive MIMO
	MOSFET	

4

	5G	4G	4G	3
2018		391	5.9%	2019
	403	3.3%		2019
	145		36%	
2020				367
9.1%		2021		
	397	8.1%		



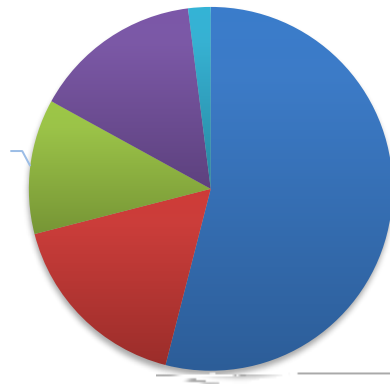
QYresearch



QYresearch

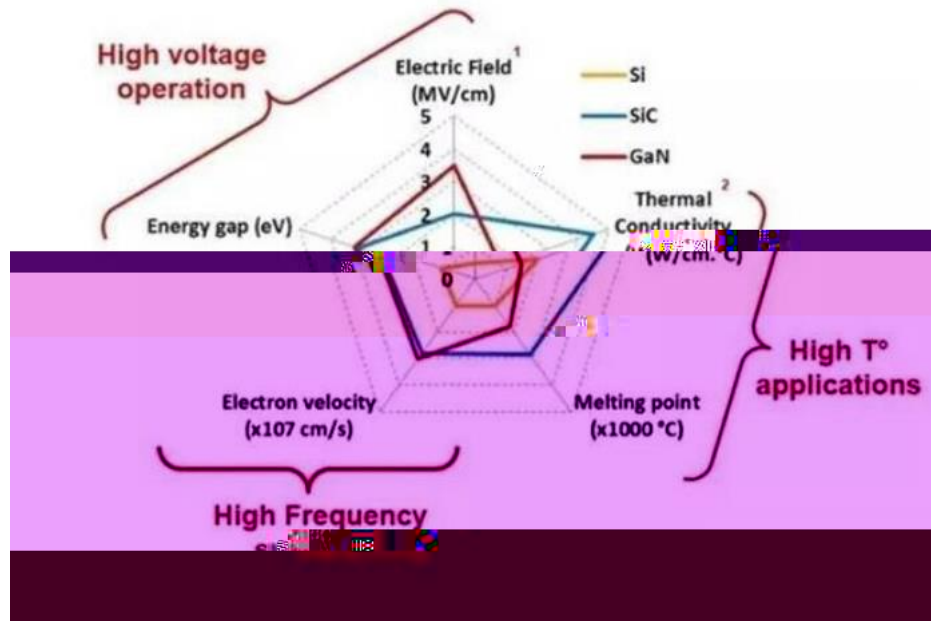
IGBT	/	17%	12%	15%	IC	54%	MOSFET
		IC MOSFET IGBT					
2018		60.98%	20.21%	13.92%			

23 2017



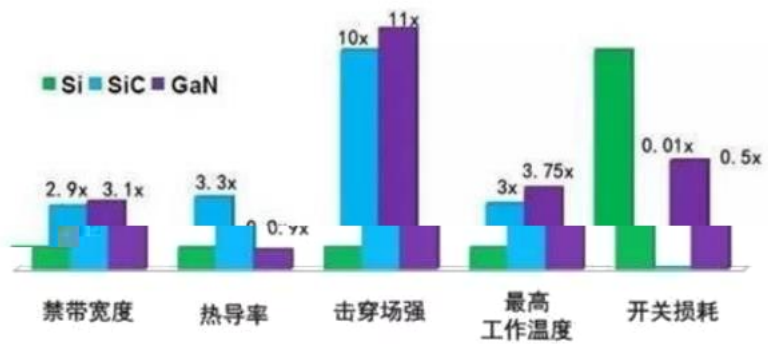
Yole IHS Gartner

IC	2016	79.65	2018	84.3	CAGR	2.88%	IC
MOSFET	2016	27.92	2018	21.10	CAGR	15.03%	BJT
IGBT	2016	15.40	2018	19.32	CAGR	11.74%	MOSFET
MOSFET							BJT



3	Si	SiC	3	3	10	600v-10kv
	1kw-500kw	10khz-10Mhz		SiC		
				Si		
	GaN					

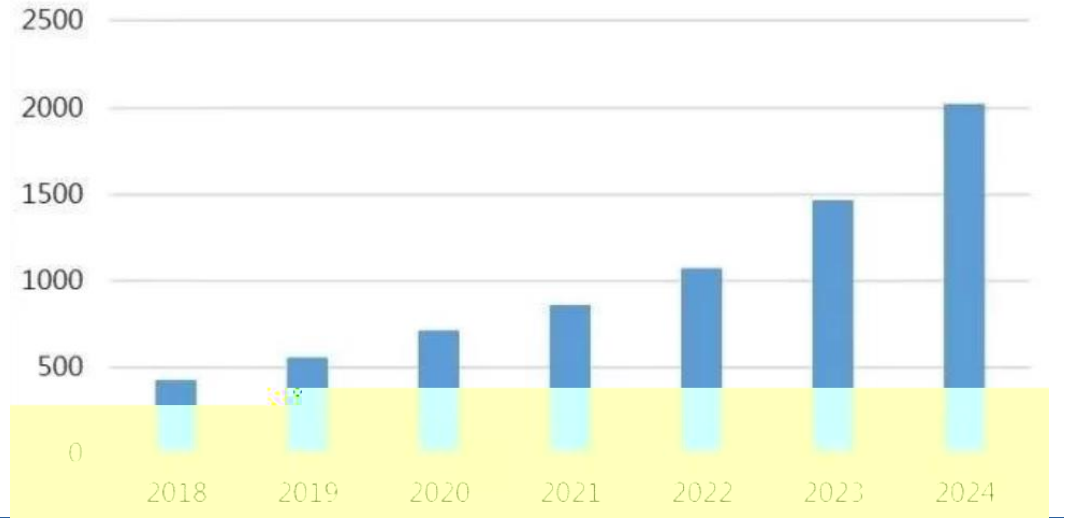
28 Si SiC GaN



- 禁带宽度: SiC材料 ~ Si材料 × 2.9; GaN材料 ~ Si材料 × 3.1
- 热导率: SiC材料 ~ Si材料 × 3.3; GaN材料 ~ Si材料 × 0.9
- 击穿场强: SiC材料 ~ Si材料 × 10; GaN材料 ~ Si材料 × 11
- 最高工作温度: SiC材料 ~ Si材料 × 3; GaN材料 ~ Si材料 × 3.75
- 开关损耗: SiC材料 ~ Si材料 × 0.01; GaN材料 ~ Si材料 × 0.5

SiC 2018 SiC CAGR 30%
 5 2024 20 SiC
 50% 2024
 GaN Yole 2020 GaN
 3 2016 2020 80%

29 SiC



Yole

GaN SiC
 650V GaN SiC JBS IDM SiC MOSFET
 1200V 650V MOSFET
 600V HEMT

3.

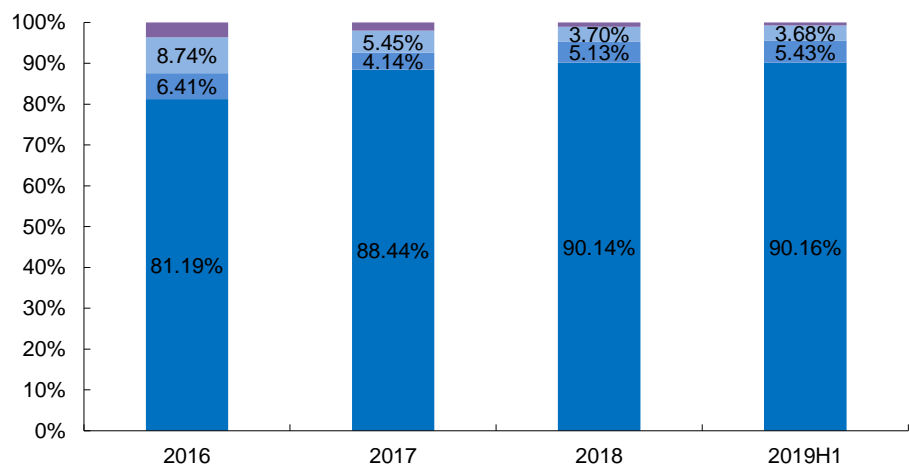
3.1

MOSFET

IDM

3.7% 90% 2018 5.13%

30



IC

MOSFET IGBT SBD FRD

2018	MOSFET	8.7%	6
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33	2018	MOSFET
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IHS

IGBT	600V-1200V	Trench-FS
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IGBT

SBD FRD

1 SBD SBD

	IC	IC	IC	
1	AC-DC			
2	LED	IC	LED	LED
3	BMS IC			
4		IC	IC	
5		IC		
6	WPC	QI		
		IC		
7		IC	BCD	CMOS



Fabless

IDM

IDM

IDM

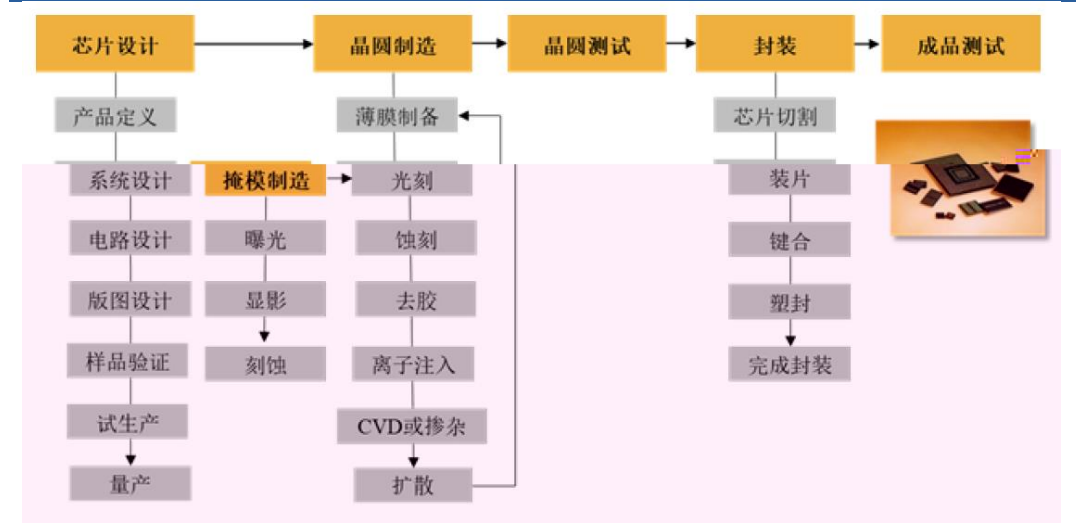
2018

IDM

IDM

IDM

36



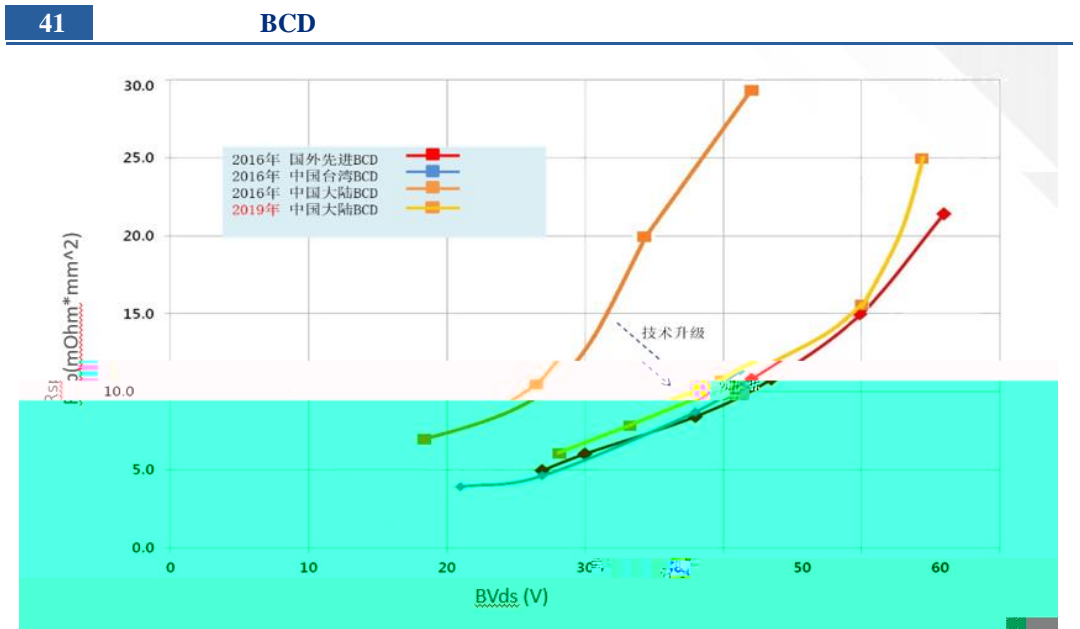
	2018		35.72	1.48%	
		26.74	4.3%	75%	
	7.86	4.2%	22%		
1.12	17.9%	3%			
	2016-2018	2019H1	7.85%	16.06%	19.49%
15.24%	2016-2018				
2019					
2016-2018	2019H1	14.27%	16.75%	15.28%	15.51%
15%					

37

38

	8			73	6	1	8	3	6
			1	8				60	247
2018	11						100		
				12				MOSFET	IGBT
			BCD	MEMS		19.2	IPO	8	
		62						2.4	

		BCD			5-700V		BCD
	BCD	SOI	BCD		BCD		
1			BCD		0.18 μ m BCD	7-120V 6	0.11 μ m
2			BCD	2007		700V CDMOS	
			2011	2013	2016	700V BCD	
			BCD				
3	SOI	BCD			SOI	BCD	
							IGBT



FC

IPM

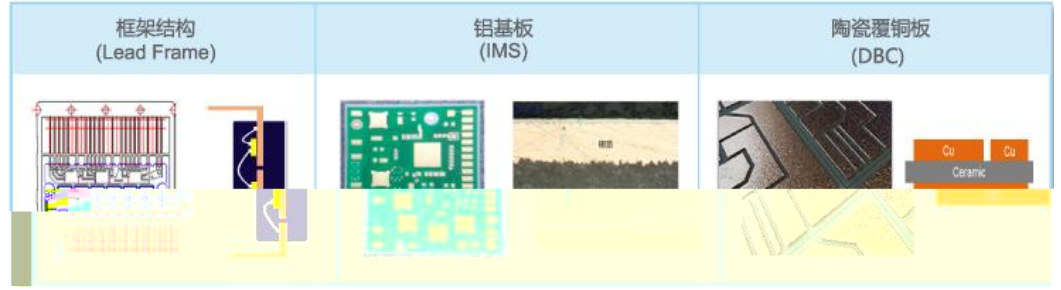
IPM

IPM

IMS

IPM

CopperClipBond
IPM



4.

IDM

			2020-2022				4.73	6.01	7.02
EPS	0.39	0.49	0.58	PE	104.60X	82.16X	70.34X		
	"	"							

减
